

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT6579074

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
PETER DIETRICH	02/02/2021
RECEIVING PARTY DATA	
Name:	HERAEUS DEUTSCHLAND GMBH & CO. KG
Street Address:	HERAEUSSTRASSE 12-14
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17259406
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DATE SIGNED:	03/02/2021
Total Attachments: 2	
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ASSIGNMENT AND DECLARATION

WHEREAS, I:

<u>Inventor</u>	<u>Citizenship</u>	<u>Address</u>
Peter DIETRICH	DE	Heraeusstrasse 12-14 63450 Hanau, Germany

(hereinafter referred to as "ASSIGNOR"), have made a discovery or invention ("INVENTION") entitled:

METAL-CERAMIC SUBSTRATE COMPRISING A FOIL AS A BOTTOM SUBSTRATE FACE, SAID FOIL BEING SHAPED FOR DIRECT COOLING

- for which an application for Letters Patent of the United States has been executed on even date herewith,
- for which an application for Letters Patent of the United States has been filed on January 11, 2021, bearing Serial No. 17/259,406.

ASSIGNMENT

WHEREAS, at the time the INVENTION was made, ASSIGNOR was under an obligation to assign all rights, title, and interest in ASSIGNOR'S INVENTION to:

Heraeus Deutschland GmbH & Co. KG
(a German Corporation)
Heraeusstrasse 12-14
63450 Hanau
Germany

and its legal representatives, successors, and assigns (hereinafter referred to as "ASSIGNEE"), which desires to formalize the assignment and its ownership of the entire interest in, to and under said INVENTION and in, to and under any and all applications for patent thereon and all Letters Patent which may be granted thereon.

NOW, THEREFORE, for valuable consideration received by ASSIGNOR, receipt and sufficiency of which is hereby acknowledged and agreed, and intending to be legally bound hereby, ASSIGNOR has assigned and hereby assign to ASSIGNEE, the entire right, title and interest to said INVENTION in the United States and its territorial possessions and in all foreign countries and to all Letters Patent or similar legal protection in the United States and its territorial possessions and in any and all foreign countries to be obtained for said INVENTION by said applications or any patent applications related thereto, including, but not limited to, continuations, divisionals, reexaminations or reissues thereof or

any legal equivalent thereof in the United States and all foreign countries for the full term or terms for which the same may be granted.

I, SAID ASSIGNOR, hereby covenant that we have full right to convey the entire right, title and interest herein to ASSIGNEE;

I, SAID ASSIGNOR, hereby authorize ASSIGNEE, or its representatives, to insert the filing date and serial number of the application when these are known;

AND I, SAID ASSIGNOR, hereby further covenant and agree that the ASSIGNEE may apply for foreign Letters Patent on said INVENTION, and that we will, at any time, when called upon to do so by the ASSIGNEE communicate to the ASSIGNEE as the case may be, any facts known to us respecting said INVENTION, and execute and deliver any and all lawful papers that may be necessary or desirable to perfect the title to the said INVENTION, the said applications and the said Letters Patent in the ASSIGNEE and that if reissues of the said Letters Patent or disclaimers relating thereto, or continuations, divisionals, reexaminations, or reissues of the said applications, or any thereof, shall hereafter be desired by the ASSIGNEE, we will, at any time, when requested by ASSIGNEE, sign all lawful papers, make all rightful oaths, execute and deliver all such disclaimers and all continuations, divisionals, reexaminations, or reissues of said applications so desired, and generally do everything possible to aid ASSIGNEE to obtain and enforce proper patent protection for said INVENTION, and without further compensation, but at the expense of the ASSIGNEE.

DECLARATION

As an above-named inventor, I hereby declare that:

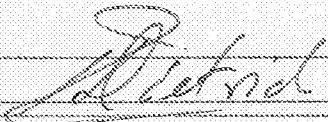
This declaration is directed to the United States application referenced above.

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention (or claimed design) in the above-identified application for which this declaration is being submitted.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Signature: 	Date: <u>Feb. 02, 2021</u>
Legal Name of Inventor: Peter DIETRICH	Citizenship: <u>DE</u>